



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



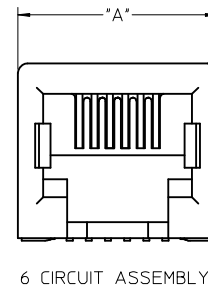
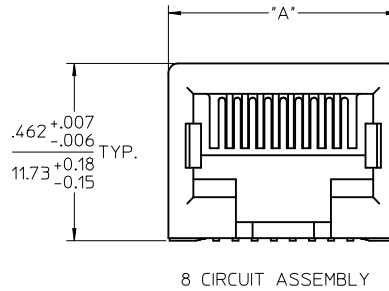
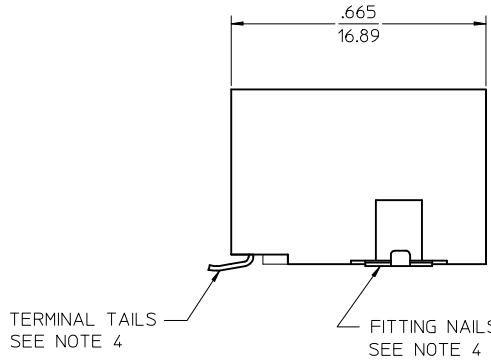
Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

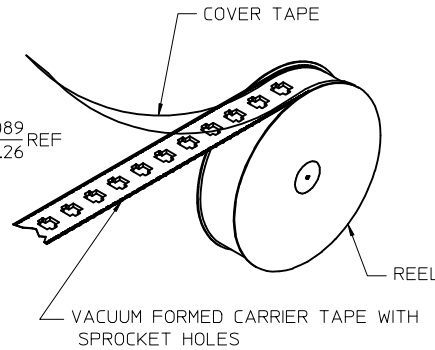
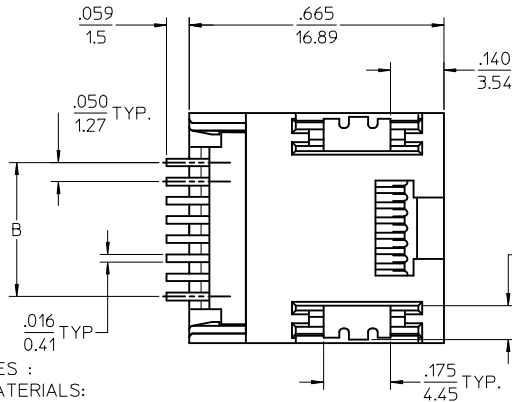
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





HOUSING SIZE	CIRCUIT SIZE	DIM. A	DIM. B
6	6	.520 (13.21)	.250 (6.35)
6	4	.520 (13.21)	.150 (3.81)
6	2	.520 (13.21)	.050 (1.27)
8	8	.600 (15.24)	.350 (8.89)
8	6	.600 (15.24)	.250 (6.35)



TAPE AND REEL PACKAGING

NOTES :

1) MATERIALS:

HOUSING: NYLON, GLASS-FILLED,
UL94V-0, COLOR - SEE CHART
TERMINALS: PHOSPHOR BRONZE, .012/(0.30) THICK
FITTING NAILS: BRASS ALLOY, .010/(0.25) THICK

2) FINISH:

TERMINALS:

- (A) SELECT GOLD IN CONTACT AREA: .000050/(0.00127) MIN.,
*SELECT MATTE TIN IN PC TAIL AREA: .000100/(0.00254) MIN.,
WITH OVERALL NICKEL UNDERPLATE: .000050/(0.00127) MIN.
(B) SELECT GOLD IN CONTACT AREA: .000030/(0.00076) MIN.,
*SELECT MATTE TIN IN PC TAIL AREA: .000100/(0.00254) MIN.,
WITH OVERALL NICKEL UNDERPLATE: .000050/(0.00127) MIN.
(C) SELECT GOLD IN CONTACT AREA: .000015/(0.00038) MIN.,
*SELECT MATTE TIN IN PC TAIL AREA: .000100/(0.00254) MIN.,
WITH OVERALL NICKEL UNDERPLATE: .000050/(0.00127) MIN.

FITTING NAILS:

- *100 MICROINCHES MATTE TIN OVER 50 MICROINCHES NICKEL UNDERPLATE
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "ELV AND
RoHS COMPLIANT" CARTONS WITHOUT THIS LABEL MAY CONTAIN
PRODUCT WITH TIN-LEAD IN THE PC TAIL AND/OR FITTING NAILS.

3) PRODUCT SPECIFICATION: PS-43743-001

4) COPLANARITY SPECIFICATION:

WITH THE MODULAR JACK SITTING ON A LEVEL SURFACE, THE
MAXIMUM GAP BETWEEN THE LEVEL SURFACE AND ALL TERMINAL
TAILS AND BOTH FITTING NAILS IS .006/(0.15).

5) FOR ASSEMBLIES HAVING VOIDED CIRCUITS, THE TAIL PORTION IS CUT
AND REMOVED. THE MATING PORTION OF THE TERMINAL REMAINS INTACT.

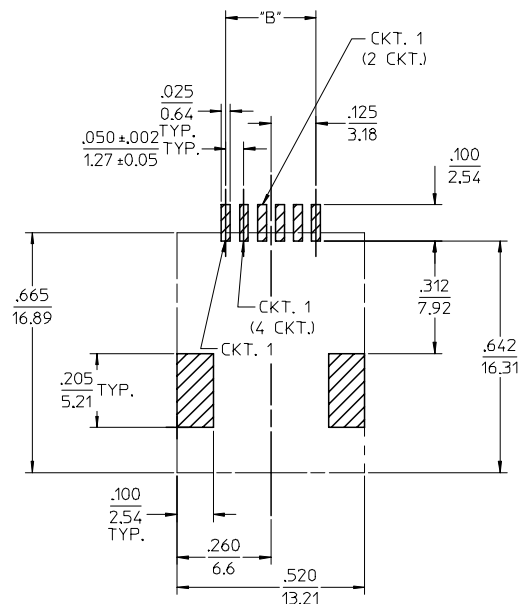
6) CONVECTION SOLDERING TECHNOLOGY SHOULD BE USED WHEN GANGING MODULAR
JACKS WITH INBOARD NAILS SIDE-BY-SIDE.

7) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.

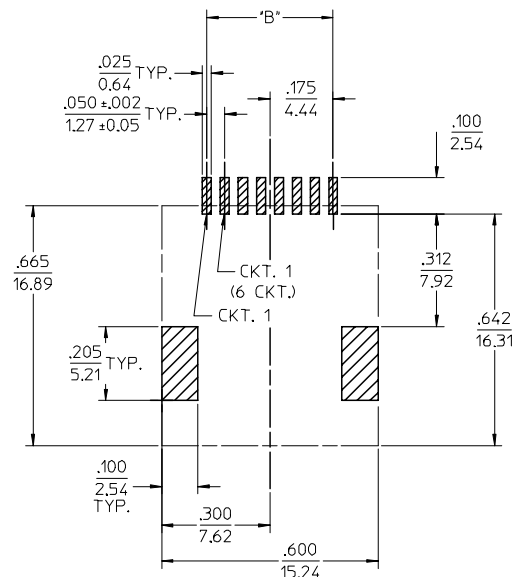
ASSEMBLY ITEM NO.	CONNECTOR SIZE	CIRCUIT SIZE	TERMINAL PLATING	TAPE & REEL PACKAGING No.	VOIDED CIRCUITS	HOUSING COLOR
44144-0001	8	4	A	PK-70873-7002	NA	BLACK
44144-0002	8	6	A	PK-70873-7002		
44144-0003	8	8	A	PK-70873-7002		
44144-0004	6	4	A	PK-70873-7001		
44144-0005	6	6	A	PK-70873-7001		
44144-0006	8	4	B	PK-70873-7002		
44144-0007	8	6	B	PK-70873-7002		
44144-0008	8	8	B	PK-70873-7002		
44144-0009	6	4	B	PK-70873-7001		
44144-0010	6	6	B	PK-70873-7001		
44144-0011	8	4	C	PK-70873-7002		
44144-0012	8	6	C	PK-70873-7002		
44144-0013	8	8	C	PK-70873-7002		
44144-0014	6	4	C	PK-70873-7001		
44144-0015	6	6	C	PK-70873-7001	NA	
44144-0016	8	4	C	PK-70873-7001	2,3,6,7	
44144-0017	6	2	A	PK-70873-7001	NA	
44144-0018	6	2	B	PK-70873-7001		
44144-0019	6	2	C	PK-70873-7001		
44144-0023	8	2	A	PK-70873-7002	NA	

2	G
1	H4
SH	REV

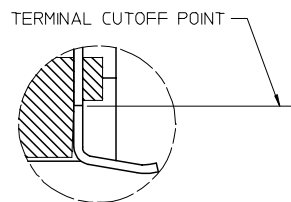
REVISED NOTES EC NO: UCP2009-1244 DRWN:JKLOSTEWER 2008/12/10 CHKD:JBELL 2008/12/10 APPR:FSM TH 2008/12/10 H4	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION	
				mm	INCH	DRAWN BY MUELLER	DATE 98/03/13	TITLE 4, 6, 8 CIRCUIT SMT MODULAR JACK W/ FLUSH FITTING NAILS		
			4 PLACES	± ---	± ---	CHECKED BY ROBERTS	DATE 98/03/16			
			3 PLACES	± ---	± .010	APPROVED BY R EDGLEY	DATE 98/03/17			
			2 PLACES	± 0.25	± .015	MATERIAL NO.	DOCUMENT NO.			
			1 PLACE	± 0.38	± ---	SEE CHART		SD-44144-001		SHEET NO. 1 OF 2
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		ANGULAR ±1/2°		MOLEX INCORPORATED			
SIZE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									



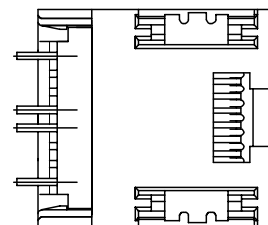
PCB LAYOUT FOR CONNECTOR SIZE 6
(COMPONENT SIDE OF BOARD)



PCB LAYOUT FOR CONNECTOR SIZE 8
(COMPONENT SIDE OF BOARD)



VIEW SHOWING TYPICAL TERMINAL
CUTOFF OF TAIL (SEE NOTE 5) FOR VOIDED CIRCUITS.



TYPICAL VIEW SHOWING VOIDED CIRCUIT
44144-0016 SHOWN

SEE SHEET ONE EC NO: UCP2004-0798 GDRW:LSCHMDT 2004/01/05 CHKD:LSCHMDT 2004/01/05 APPR:FSMITH 2004/01/08	DESCRIPTION	QUALITY SYMBOLS ▽ = 0 ▽ = 0	GENERAL TOLERANCES (UNLESS SPECIFIED)		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION	REVISE ON CAD ONLY		
			mm	INCH	DIMENSION STYLE IN/MM		TITLE 4, 6, 8 CIRCUIT SMT MODULAR JACK W/ FLUSH FITTING NAILS MOLEX MOLEX INCORPORATED			
			4 PLACES ± --- ± ---		DRAWN BY DATE DSTAMBAU 00/04/07					
			3 PLACES ± --- ± .010		CHECKED BY DATE BWIRKUS 00/04/07					
			2 PLACES ± 0.25 ± .015		APPROVED BY DATE R EDGLEY 00/04/07		MATERIAL NO.	DOCUMENT NO.	SHEET NO.	
1 PLACE ± 0.38 ± ---		DRAFT WHERE APPLICABLE		SEE CHART		SD-44144-001	2 OF 2			
MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								